2.5V Drive Nch+SBD MOSFET **US5U1**

●Structure

Silicon N-channel MOSFET/ Schottky barrier diode

● Features

- 1) Nch MOSFET and schottky barrier diode are put in TUMT5 package.
- 2) High-speed switching, Low On-resistance.
- 3) Low voltage drive (2.5V drive).
- 4) Built-in Low VF schottky barrier diode.

Applications

Switching

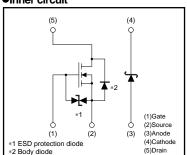
Package specifications

	Package	Taping
Type	Code	TR
	Basic ordering unit (pieces)	3000
US5U1		0

●Inner circuit

● Dimensions (Unit: mm)

TUMT5



Abbreviated symbol : U01

● Absolute maximum ratings (Ta=25°C)

<MOSFET>

Parameter	Symbol	Limits	Unit	
Drain-source voltage		Voss	30	V
Gate-source voltage		V _{GSS}	12	V
Drain current	Continuous	ID	±1.5	Α
Drain current	Pulsed	IDP *1	±6.0	Α
Source current	Continuous	Is	0.75	Α
(Body diode)	Pulsed	I _{SP} *1	6.0	Α
Power dissipation		P _D *2	0.7	W / ELEMENT
Channel temperature		Tch	150	°C

^{*1} Pw≤10µs, Duty cycle≤1% *2 Mounted on a ceramic board

<Di>

Parameter	Symbol	Limits	Unit
Repetitive peak reverse voltage	VRM	30	V
Reverse voltage	VR	20	V
Forward current	l _F	0.5	Α
Forward current surge peak	I _{FSM} *1	2.0	A
Power dissipation	P _D *2	0.5	W / ELEMENT
Junction temperature	Tj	150	°C

*2 Mounted on ceramic board

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<MOSFET and Di>

Parameter	Symbol	Limits	Unit		
Total power dissipation	P _D *1	1.0	W / TOTAL		
Range of storage temperature	Tstg	-55 to +150	°C		

^{*1} Mounted on a ceramic board

●Electrical characteristics (Ta=25°C)

<MOSFET>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	I _{GSS}	-	-	10	μА	V _{GS} =12V, V _{DS} =0V
Drain-source breakdown voltage	V(BR) DSS	30	-	_	V	ID= 1mA, VGS=0V
Zero gate voltage drain current	IDSS	-	-	1	μΑ	V _{DS} = 30V, V _{GS} =0V
Gate threshold voltage	V _{GS (th)}	0.5	-	1.5	V	V _{DS} = 10V, I _D = 1mA
Otatia daria assura a stata		_	170	240	mΩ	I _D = 1.5A, V _{GS} = 4.5V
Static drain-source on-state resistance	R _{DS (on)} *	-	180	250	mΩ	I _D = 1.5A, V _{GS} = 4V
resistance		-	240	340	mΩ	Ip= 1.5A, Vgs= 2.5V
Forward transfer admittance	Y _{fs} *	1.5	-	-	S	V _{DS} = 10V, I _D = 1.5A
Input capacitance	Ciss	-	80	_	pF	Vps= 10V
Output capacitance	Coss	-	14	_	pF	V _{GS} =0V
Reverse transfer capacitance	Crss	-	12	-	pF	f=1MHz
Turn-on delay time	t _{d (on)} *	_	7	_	ns	Vpp≒ 15V
Rise time	tr *	-	9	_	ns	ID= 0.75A VGS= 4.5V
Turn-off delay time	td (off) *	-	15	-	ns	$R_{i} = 20\Omega$
Fall time	t _f *	-	6	-	ns	R _G =10Ω
Total gate charge	Qg *	-	1.6	2.2	nC	V _{DD} ≒ 15V, V _{GS} = 4.5V
Gate-source charge	Q _{gs} *	-	0.5	-	nC	I _D = 1.5A
Gate-drain charge	Q _{gd} *	-	0.3	-	nC	$R_L=10\Omega$, $R_G=10\Omega$

^{*}Pulsed

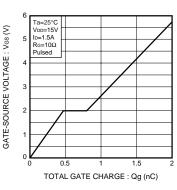
<Body diode characteristics (Source-drain)>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	Vsp	-	ı	1.2	V	Is= 0.75A, Vgs=0V

<Di>

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	VF	-	-	0.36	V	Is= 0.1A
		-	-	0.47	V	Is= 0.5A
Reverse current	lr	_	-	100	μΑ	Is= 20V

PElectrical characteristics curves Ta=25°C Vosa-45V Rea-1002 Pulsed Ta=25°C Pulsed



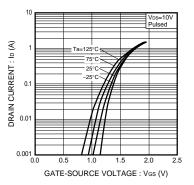


Fig.2 Dynamic Input Characteristics

Fig.3 Typical Transfer Characteristics

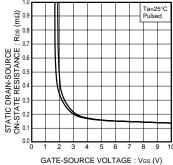


Fig.4 Static Drain-Source On-State Resistance vs. Gate source Voltage

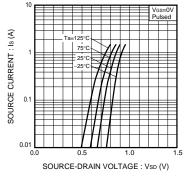


Fig.5 Source Current vs. Source-Drain Voltage

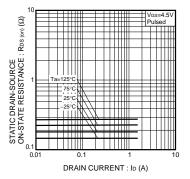


Fig.6 Static Drain-Source On-State Resistance vs. Drain Current (I)

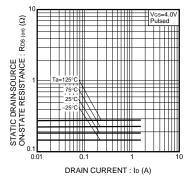


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current (II)

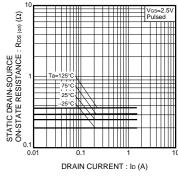


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current (III)

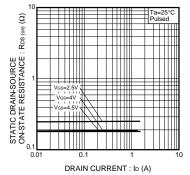


Fig.9 Static Drain-Source On-State Resistance vs. Drain Current (IV)

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